

## Description

The VSM5N20 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

## General Features

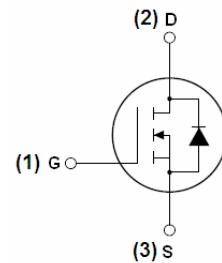
- $V_{DS} = 200V, I_D = 8A$
- $R_{DS(ON)} < 300m\Omega @ V_{GS}=10V$  (Typ: 260m $\Omega$ )
- High density cell design for ultra low  $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

## Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



TO-252



Schematic Diagram

## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM5N20-T2	VSM5N20	TO-252	-	-	-

## Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	200	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	8	A
Drain Current-Continuous( $T_c=100^\circ C$ )	$I_D (100^\circ C)$	5.6	A
Pulsed Drain Current	$I_{DM}$	20	A
Maximum Power Dissipation	$P_D$	55	W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	°C

## Thermal Characteristic

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	$R_{eJC}$	2.3	°C/W
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**Electrical Characteristics ( $T_c=25^\circ\text{C}$  unless otherwise noted)**

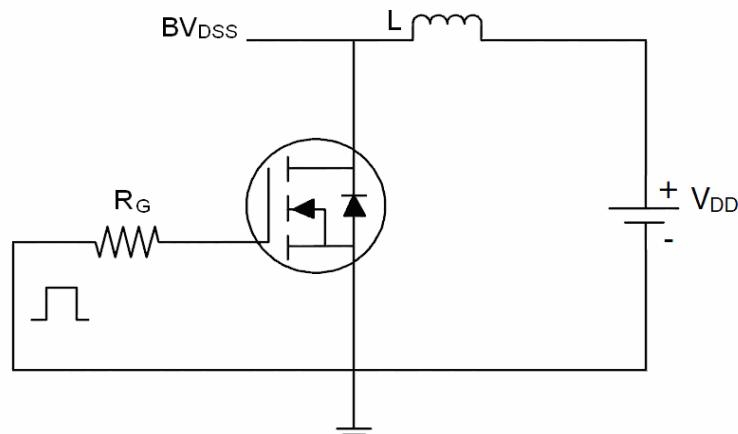
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	200	215	-	V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=200\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Body Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b> <sup>(Note 3)</sup>						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	1	1.7	2.5	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=4.5\text{A}$	-	260	300	$\text{m}\Omega$
Forward Transconductance	$\text{g}_{\text{FS}}$	$\text{V}_{\text{DS}}=25\text{V}, \text{I}_D=4.5\text{A}$	3	-	-	S
<b>Dynamic Characteristics</b> <sup>(Note 4)</sup>						
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=25\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $F=1.0\text{MHz}$		540		PF
Output Capacitance	$\text{C}_{\text{oss}}$			90		PF
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$			35		PF
<b>Switching Characteristics</b> <sup>(Note 4)</sup>						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=100\text{V}, \text{I}_D=4.5\text{A}$ $\text{V}_{\text{GS}}=10\text{V}, \text{R}_{\text{GEN}}=5\Omega$	-	6.4	-	nS
Turn-on Rise Time	$t_r$		-	11	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	20	-	nS
Turn-Off Fall Time	$t_f$		-	12	-	nS
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=160\text{V}, \text{I}_D=4.5\text{A},$ $\text{V}_{\text{GS}}=10\text{V}$	-	16	-	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$		-	3.4	-	nC
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		-	5.1	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage <sup>(Note 3)</sup>	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_S=8\text{A}$	-	-	1.2	V
Diode Forward Current <sup>(Note 2)</sup>	$\text{I}_S$		-	-	8	A

**Notes:**

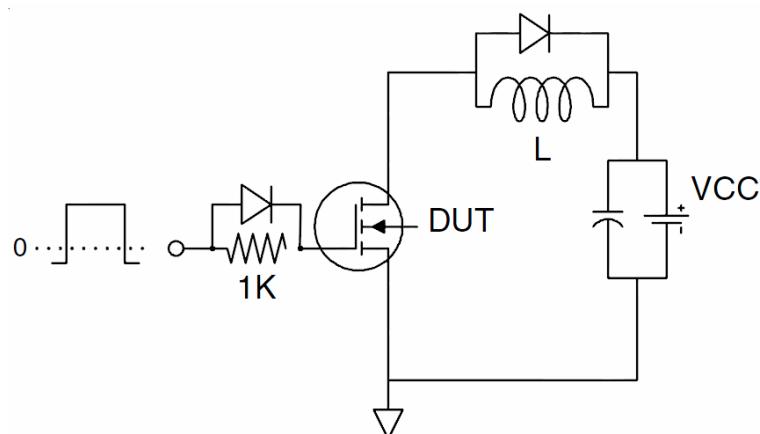
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

## Test Circuit

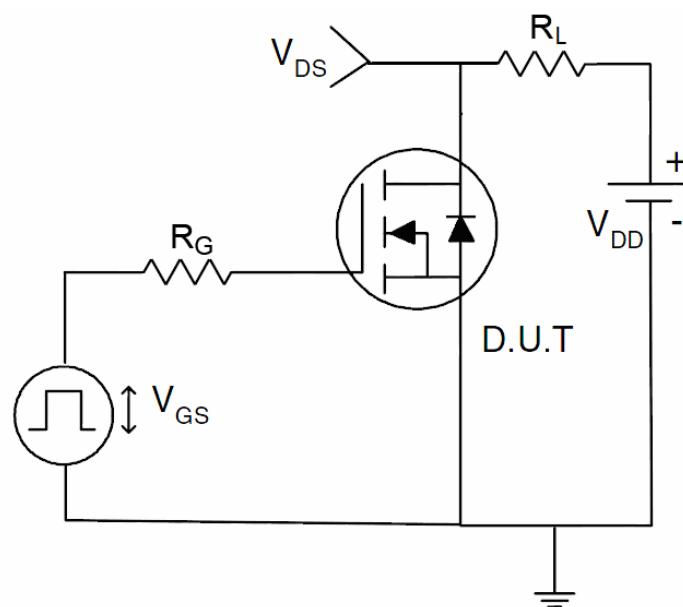
### 1) E<sub>AS</sub> test Circuit



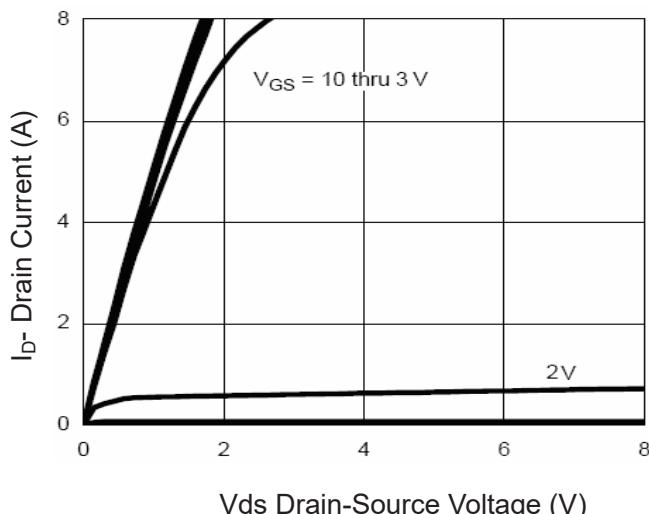
### 2) Gate charge test Circuit



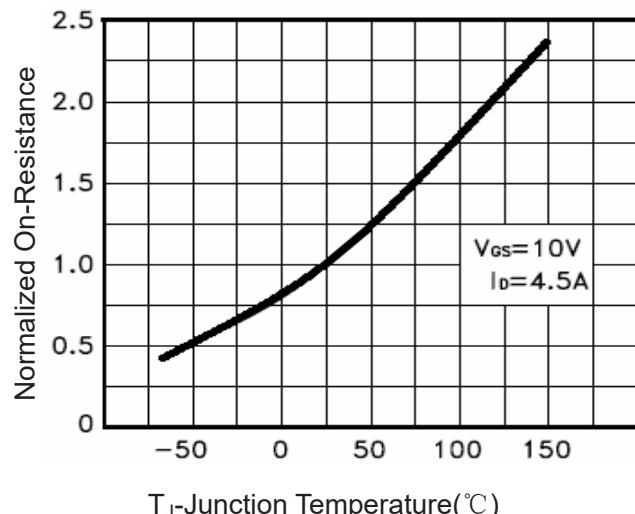
### 3) Switch Time Test Circuit



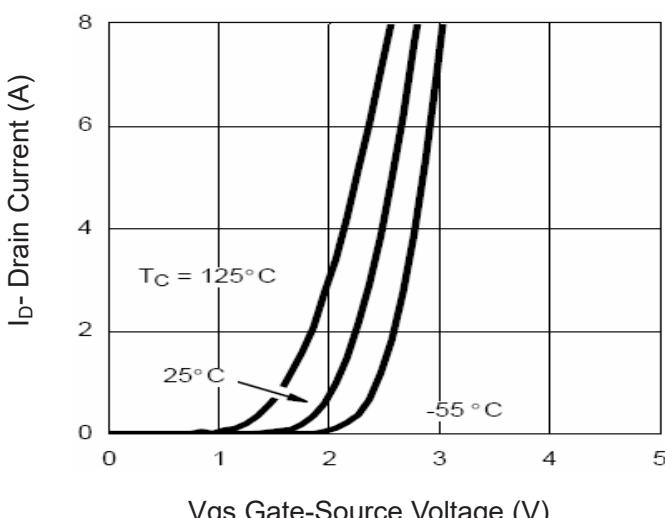
### Typical Electrical and Thermal Characteristics (Curves)



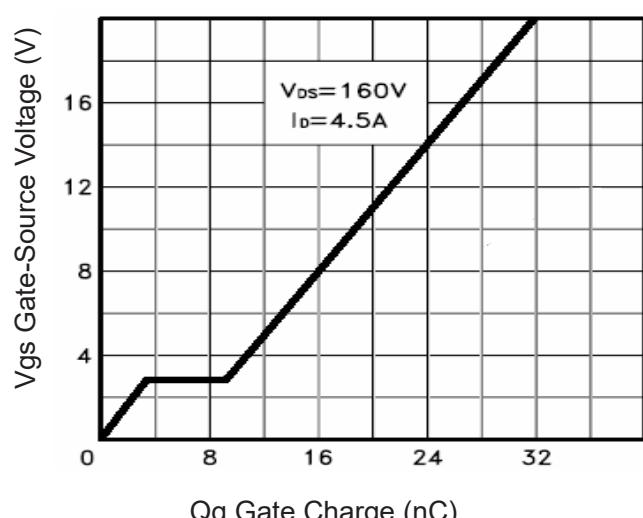
**Figure 1 Output Characteristics**



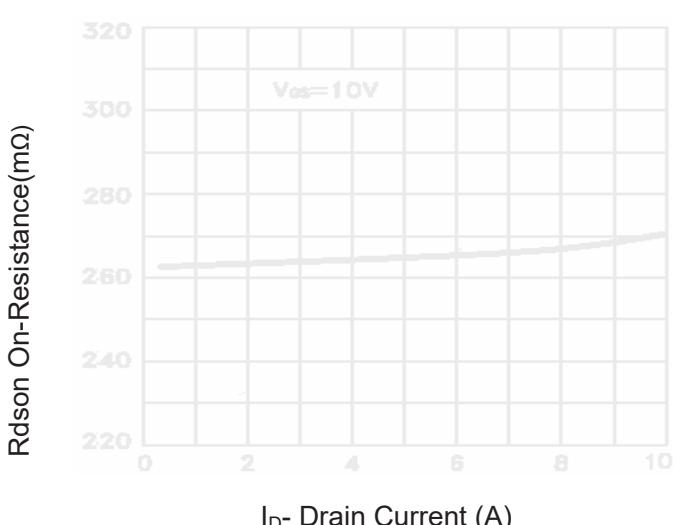
**Figure 4  $R_{DSON}$ -Junction Temperature**



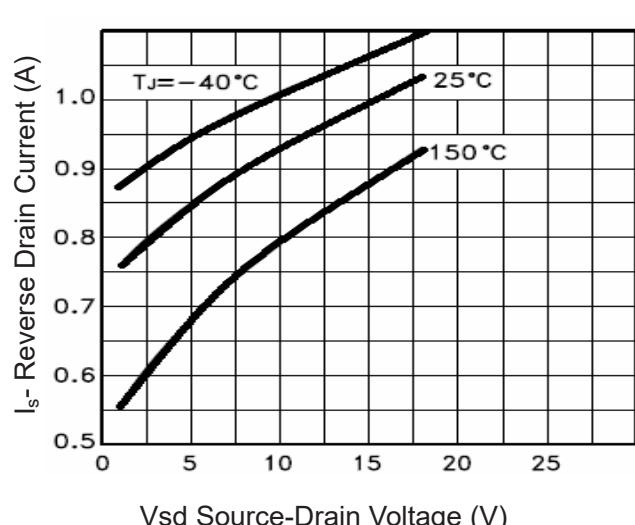
**Figure 2 Transfer Characteristics**



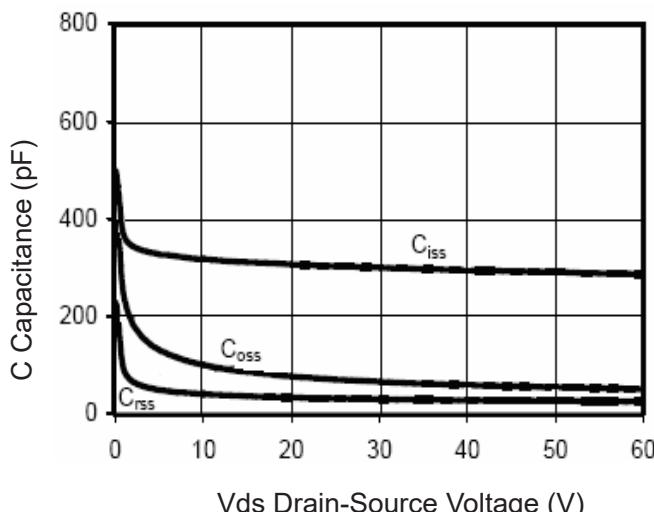
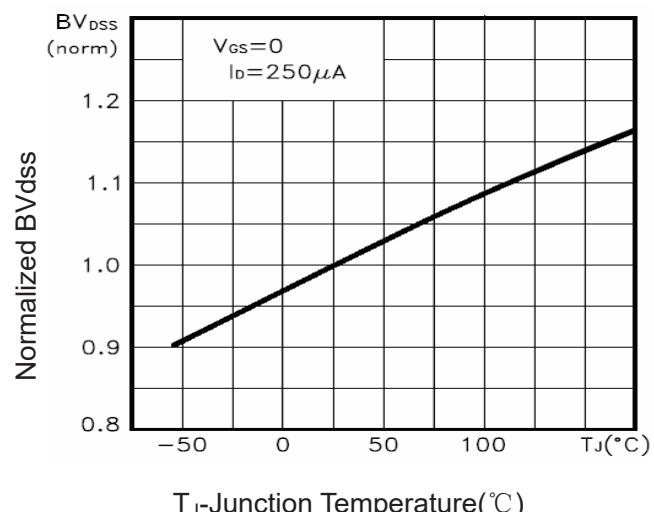
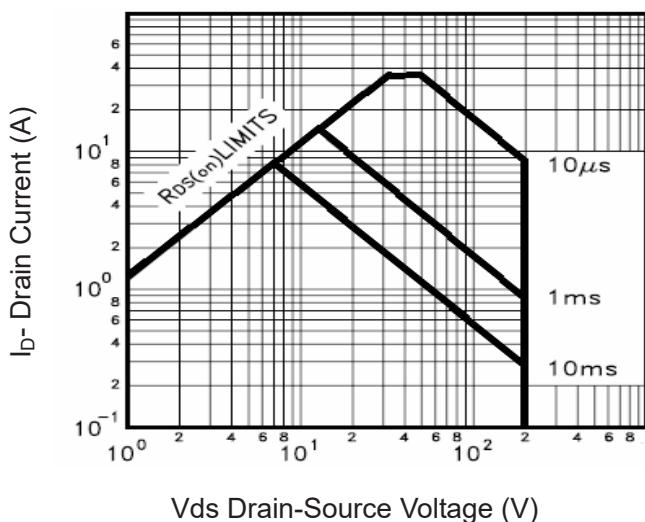
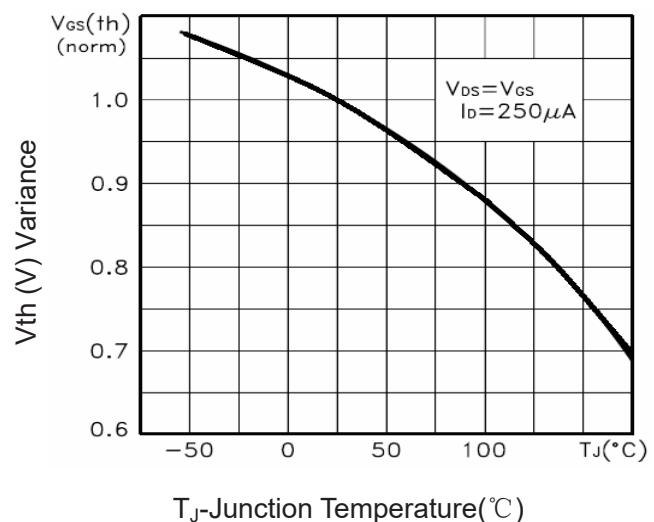
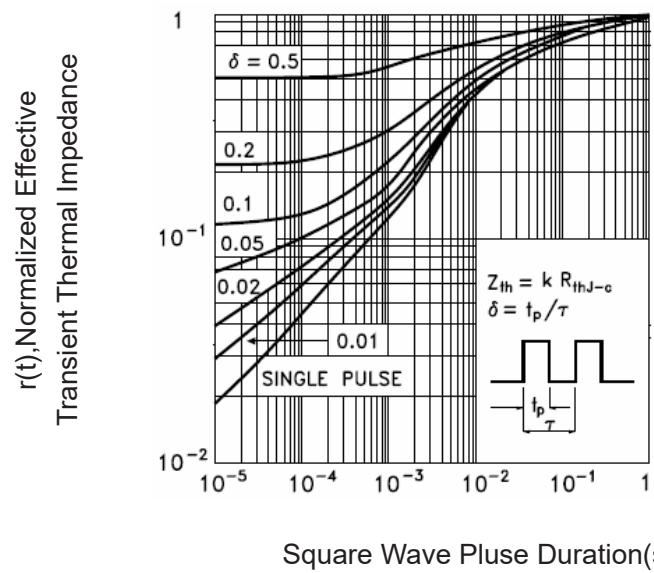
**Figure 5 Gate Charge**



**Figure 3  $R_{DSON}$ -Drain Current**



**Figure 6 Source-Drain Diode Forward**


**Figure 7 Capacitance vs Vds**

**Figure 9  $BV_{dss}$  vs Junction Temperature**

**Figure 8 Safe Operation Area**

**Figure 10  $V_{GS(th)}$  vs Junction Temperature**

**Figure 11 Normalized Maximum Transient Thermal Impedance**